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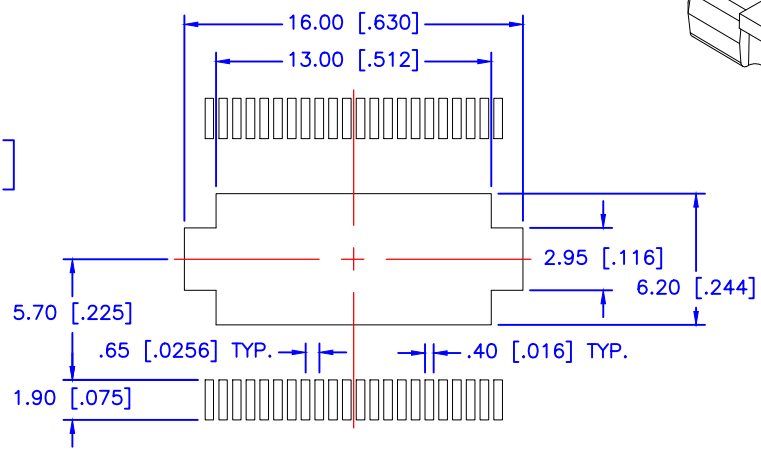
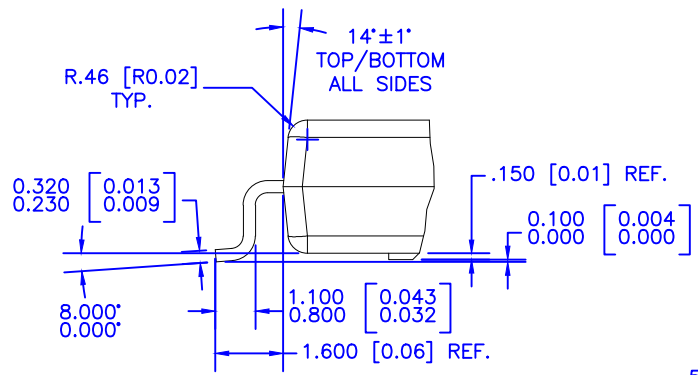
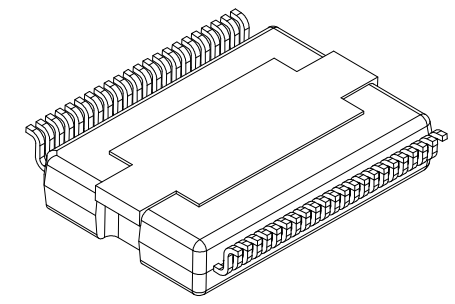
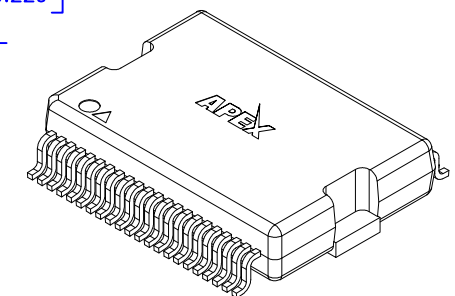
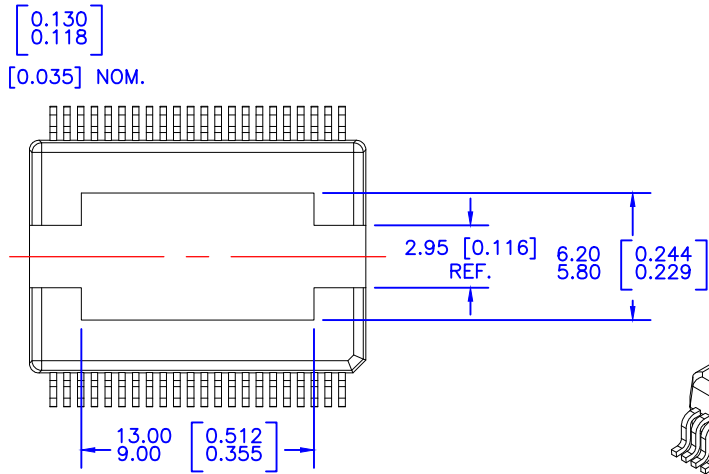
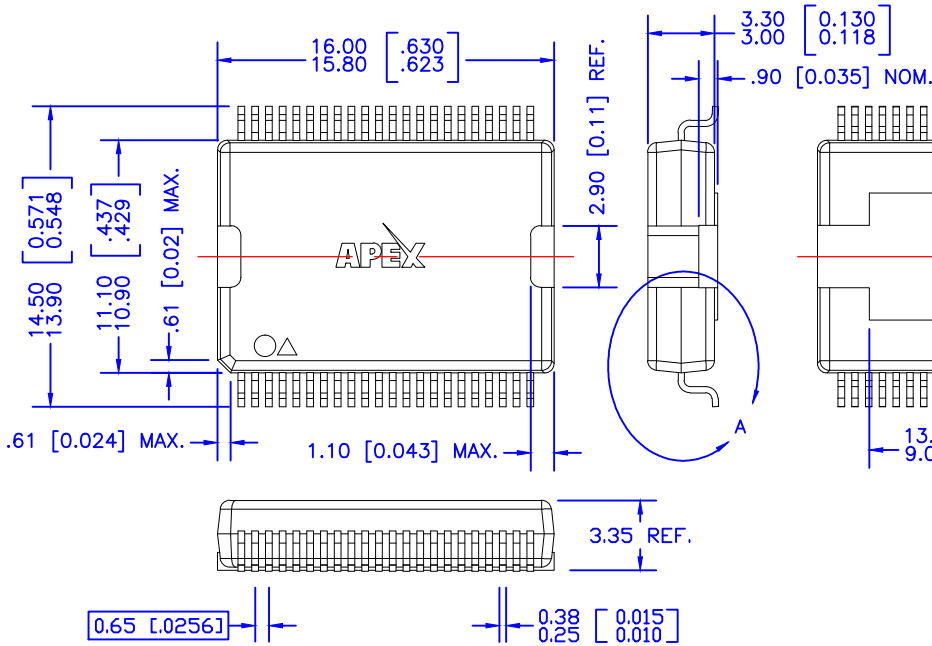
C

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B

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NOTES:

1. Dimensions are millimeters & [inches].
2. Bracketed alternate units are for reference only.
3. Dimple on lid & ESD triangle denote pin 1.
4. Pins & Heat Slug: C19400 & C10200 copper with plated finish.
5. Mold compound: Epoxy
6. Package weight: .086 oz. [2.44 g]
7. Suggested surface mount layout for reference only.

TOLERANCES - UNLESS OTHERWISE SPECIFIED			TITLE JEDEC MO-166, 44-pin HSOP SLUG-DN SUBJECT PACKAGE OUTLINE				MODEL HR	
.XX = ±.01 [.254] .XXX = ±.005 [.127] ANG. = ±5°			ENGINEER J.MUTZ DRAWN BY J.FAY DCA 16319	CHK 1 OF 1	FILENAME HR REV D DATE 04AUG16			

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